

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



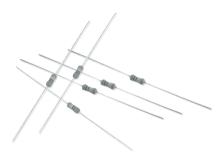






# High Power Type

Ultra Miniature Style [FMP Series]



#### **INTRODUCTION**

The FMP Series Metal Film High Power Resistors are manufactured using a vacuum sputtering system to deposit multiple layers of mixed metal alloys and passivative materials onto a carefully treated high grade ceramic substrate. After a helical groove has been cut in the resistive layer, tinned connecting leads of electrolytic copper are welded to the end-caps. The resistors are coated with layers of pink color lacquer.

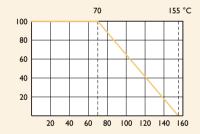
#### **FEATURES**

Power Rating	1/2W, 1W, 2W, 3W,4W
Resistance Tolerance	±1%, ±5%
T.C.R.	±100ppm/°C
Flameproof Multi-layer Coating Meets	UL-94V-0
Flameproof Feature Meets Overload Test	UL-1412

#### **DERATING CURVE**

For resistors operated in ambient temperatures above 70°C, power rating must be derated in accordance with the curve below.

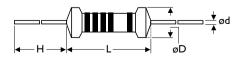
#### Rated Load (%)



Ambient Temperature (°C)

#### **DIMENSIONS**

Unit: mm



STYLE	DIMENSION	ı		
Ultra Miniature	L	øD	н	ød
FMP-50	3.4±0.3	1.9±0.2	28±2.0	0.45±0.05
FMP100	6.3±0.5	2.4±0.2	28±2.0	0.55±0.05
FMP200	9.0±0.5	3.9±0.3	26±2.0	0.55±0.05
FMP3WS	11.5±1.0	4.5±0.5	35±2.0	0.8±0.05
FMP300	15.5±1.0	5.0±0.5	33±2.0	0.8±0.05
FMP4WV	17.0±1.0	7.5±0.5	32±2.0	0.8±0.05

Note:			

## **ELECTRICAL CHARACTERISTICS**

STYLE	FMP-50	FMPI00	FMP200	FMP3WS	FMP300	FMP4WV
Power Rating at 70°C	1/2W	IW	2W	3W		4W
Maximum Working Voltage	200V	350V	500V		750V	
Maximum Overload Voltage	400V	600V	700V		I,000V	
Voltage Proof	300V	500V			750V	
Resistance Range	ΙΩ-ΙΟΜΩ&	I $\Omega$ - IOM $\Omega$ & 0 $\Omega$ for E24 & E96 series value				
Operating Temp. Range	-55°C to +155°	-55°C to +155°C				
Temperature Coefficient	±100ppm/°C					

Note: Special value is available on request

## **ENVIRONMENTAL CHARACTERISTICS**

PERFORMANCE TEST	TEST METHOD	APPRAISE		
Short Time Overload	IEC 60115-1 4.13	2.5 times RCWV for 5 Sec.	±0.5%+0.05 Ω	
Voltage Proof	IEC 60115-1 4.7	in V-block for 60 Sec., test voltage by type	By type	
Temperature Coefficient	IEC 60115-1 4.8	-55°C to +155°C	By type	
Insulation Resistance	IEC 60115-1 4.6	in V-block for 60 Sec.	>1,000M Ω	
Solderability	IEC 60115-1 4.17	235±5°C for 3±0.5 Sec.	95% Min. coverage	
Solvent Resistance of Marking	IEC 60115-1 4.30	IPA for 5±0.5 Min, with ultrasonic	No deterioration of coatings and markings	
Robustness of Terminations	IEC 60115-1 4.16	Direct load for 10 Sec. in the direction of the terminal leads	≥2.5kg (24.5N)	
Periodic-pulse Overload	IEC 60115-1 4.39	4 times RCWV 10,000 cycles (1 Sec. on, 25 Sec. off)	±1.0%+0.05 Ω	
Damp Heat Steady State	IEC 60115-1 4.24	40±2°C, 90-95% RH for 56 days, loaded with 0.1 times RCWV	±2.0%+0.05 Ω	
Endurance at 70°C	IEC 60115-1 4.25	70±2°C at RCWV for 1,000 Hr. (1.5 Hr. on, 0.5 Hr. off)	±2.0%+0.05 Ω	
Temperature Cycling	IEC 60115-1 4.19	-55°C ⇒ Room Temp. ⇒ +155°C ⇒ Room Temp. (5 cycles)	±1.0%+0.05 Ω	
Resistance to Soldering Heat	IEC 60115-1 4.18	260±3°C for 10±1 Sec., immersed to a point 3±0.5mm from the body	±0.25%+0.05 Ω	
Accidental Overload Test	IEC 60115-1 4.26	4 times RCWV for 1 Min.	No evidence of flaming or arcing	